



**THE DATASHEET OF  
DFLR1800-7**



**Product Summary (@T<sub>A</sub> = +25°C)**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>FMAX</sub> (V)	I <sub>RMAX</sub> (μA)
800	1	1.1	10

**Description and Applications**

Packaged in the compact thermally efficient POWERDI123 package, the DFLR1800 provides high surge capacity and high efficiency. It is ideally suited to use in

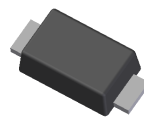
- AC/DC Adaptors/Chargers
- DC/DC Converters
- Power Supply

**Features and Benefits**

- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- Patented Interlocking Clip Design for High Surge Capacity, US Patent #7,095,113

**Mechanical Data**

- Case: PowerDI123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ⑥3
- Weight: 0.01 grams (approximate)

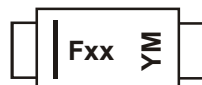


Top View

**Ordering Information (Note 4)**

Part Number	Marking Code	Case	Packaging
DFLR1800-7	F18 or F18	PowerDI®123	3000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

**Marking Information**


Fxx = Product Type Marking Code  
 F18 or F18 = DFLR1800  
 YM = Date Code Marking  
 Y = Year (ex: B = 2014)  
 M = Month (ex: 9 = September)

## Date Code Key

Year	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019
Code	X	Y	Z	A	B	C	D	E	F	G

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	800	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
Average Rectified Output Current (see figure 4)	I <sub>O</sub>	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	25	A

**Thermal Characteristics**

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	134	—	°C/W
Thermal Resistance, Junction to Soldering Point (Note 6)	R <sub>θJS</sub>	—	6	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	—	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	800	—	—	V	I <sub>R</sub> = 10μA
Forward Voltage Drop	V <sub>F</sub>	—	0.65	—	V	I <sub>F</sub> = 1.0mA, T <sub>J</sub> = 0°C
		—	0.60	—		I <sub>F</sub> = 1.0mA, T <sub>J</sub> = +25°C
		—	0.48	—		I <sub>F</sub> = 1.0mA, T <sub>J</sub> = +85°C
		—	0.94	1.1		I <sub>F</sub> = 1.0A, T <sub>J</sub> = +25°C
		—	0.83	1.0		I <sub>F</sub> = 1.0A, T <sub>J</sub> = +125°C
Reverse Leakage Current (Note 7)	I <sub>R</sub>	—	—	10 150	μA	V <sub>R</sub> = 800V, T <sub>J</sub> = +25°C V <sub>R</sub> = 800V, T <sub>J</sub> = +125°C
Total Capacitance	C <sub>T</sub>	—	10	—	pF	V <sub>R</sub> = 4.0V <sub>DC</sub> , f = 1MHz

- Notes:
5. Device mounted on 1" x 1", FR-4 PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document AP02001.pdf. T<sub>A</sub> = +25°C
  6. Theoretical R<sub>θJS</sub> calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
  7. Short duration test pulse used to minimize self-heating effect.
  8. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

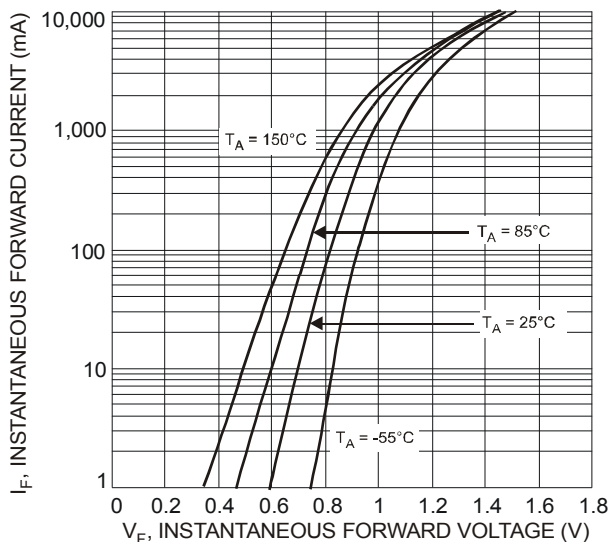


Figure 1 Typical Forward Characteristics

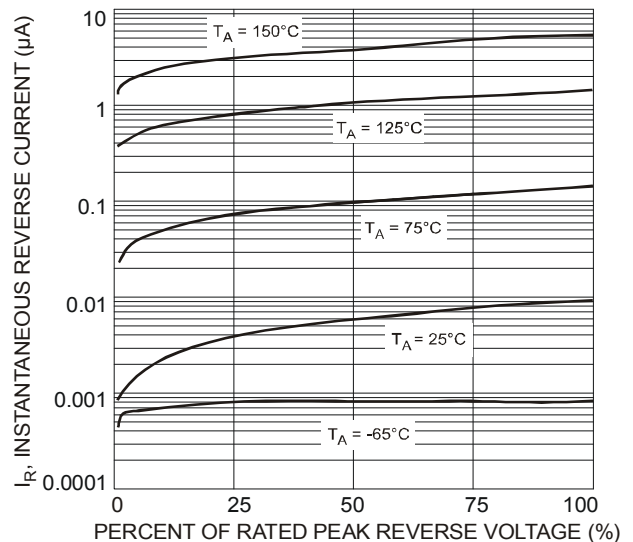


Figure 2 Typical Reverse Characteristics

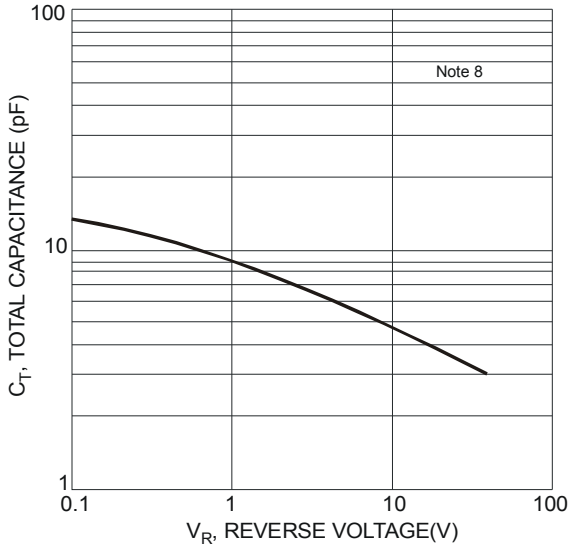


Figure 3 Typical Junction Capacitance

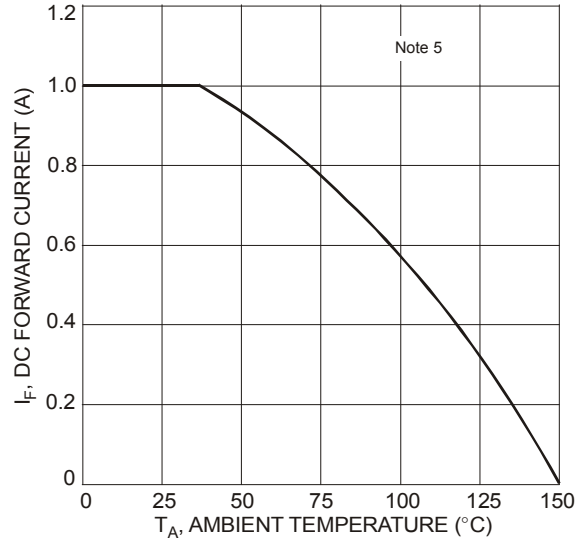


Figure 4 DC Forward Current Derating

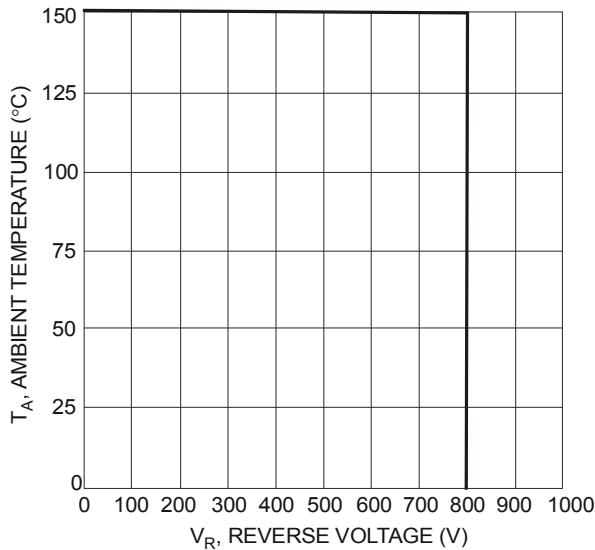


Figure 5 Reverse Voltage Derating

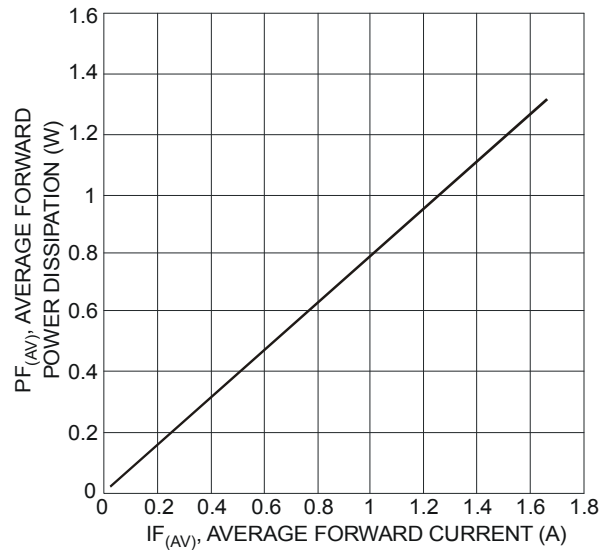
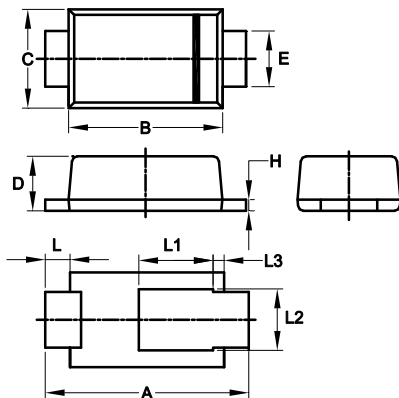


Figure 6 Forward Power Dissipation

## Package Outline Dimensions

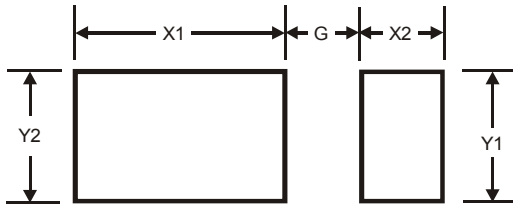
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



POWERDI <sup>®</sup> 123			
Dim	Min	Max	Typ
A	3.50	3.90	3.70
B	2.60	3.00	2.80
C	1.63	1.93	1.78
D	0.93	1.00	0.98
E	0.85	1.25	1.00
H	0.15	0.25	0.20
L	0.40	0.50	0.45
L1	1.25	1.40	1.35
L2	1.025	1.125	1.10
L3	0.125	0.275	0.20
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
<b>G</b>	1.0
<b>X1</b>	2.2
<b>X2</b>	0.9
<b>Y1</b>	1.4
<b>Y2</b>	1.4

### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.



Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2014, Diodes Incorporated

[www.diodes.com](http://www.diodes.com)

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

-  [View DFLR1800-7 on WIN SOURCE](#)
-  [Diodes Incorporated Information](#)

## Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management